

CIRCUITS	DIM A	DIM B	DIM C	DIM D	W/O PEG	WITH PEG
10	2.00	4.03	5.00	3.70		⊕
12	2.50	4.53	5.50	4.20		⊕
14	3.00	5.03	6.00	4.70		⊕
16	3.50	5.53	6.50	5.20		⊕
18	4.00	6.03	7.00	5.70		⊕
20	4.50	6.53	7.50	6.20		⊕
22	5.00	7.03	8.00	6.70		⊕
24	5.50	7.53	8.50	7.20		⊕
26	6.00	8.03	9.00	7.70		⊕
28	6.50	8.53	9.50	8.20		⊕
30	7.00	9.03	10.00	8.70		⊕
32	7.50	9.50	10.50	9.20		⊕
34	8.00	10.03	11.00	9.70		⊕
36	8.50	10.53	11.50	10.20		⊕
38	9.00	11.03	12.00	10.70		⊕
40	9.50	11.53	12.50	11.20		⊕
42	10.00	12.03	13.00	11.70		⊕
44	10.50	12.53	13.50	12.20		⊕
46	11.00	13.03	14.00	12.70		⊕
48	11.50	13.53	14.50	13.20		⊕
50	12.00	14.03	15.00	13.70		⊕
52	12.50	14.53	15.50	14.20		⊕
54	13.00	15.03	16.00	14.70		⊕
56	13.50	15.53	16.50	15.20		⊕
58	14.00	16.03	17.00	15.70		⊕
60	14.50	16.53	17.50	16.20		⊕
62	15.00	17.03	18.00	16.70		⊕
64	15.50	17.53	18.50	17.20		⊕
66	16.00	18.03	19.00	17.70		⊕
68	16.50	18.53	19.50	18.20		⊕
70	17.00	19.03	20.00	18.70		⊕
72	17.50	19.53	20.50	19.20		⊕
74	18.00	20.03	21.00	19.70		⊕
76	18.50	20.53	21.50	20.20		⊕
78	19.00	21.03	22.00	20.70		⊕
80	19.50	21.53	22.50	21.20		⊕
82	20.00	22.03	23.00	21.70		⊕
84	20.50	22.53	23.50	22.20		⊕
86	21.00	23.03	24.00	22.70		⊕
88	21.50	23.53	24.50	23.20		⊕
90	22.00	24.03	25.00	23.70		⊕
92	22.50	24.53	25.50	24.20		⊕
94	23.00	25.03	26.00	24.70		⊕
96	23.50	25.53	26.50	25.20		⊕
98	24.00	26.03	27.00	25.70		⊕
100	24.50	26.53	27.50	26.20		⊕
102	25.00	27.03	28.00	26.70		⊕
104	25.50	27.53	28.50	27.20		⊕
106	26.00	28.03	29.00	27.70		⊕
108	26.50	28.53	29.50	28.20		⊕
110	27.00	29.03	30.00	28.70		⊕
112	27.50	29.53	30.50	29.20		⊕
116	28.00	30.03	31.00	29.70		⊕
118	28.50	30.53	31.50	30.20		⊕
120	29.00	31.03	32.00	30.70		⊕

Diagram	Molding description
○	mass production & assemble mold
⊙	sample & assemble mold
⊕	mass production & fix mold
⊕	sample & fix mold

GENERAL TOLERANCE	
XX. ± 0.50	XXX. ±
X. ± 0.40	.XXX ±
.X ± 0.25	X.° ± 4°
.XX ± 0.20	.X° ± 4°

SCALE	1=1
UNIT	MM
SIZE	A4

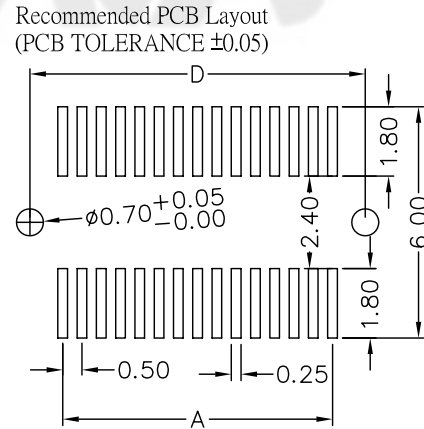
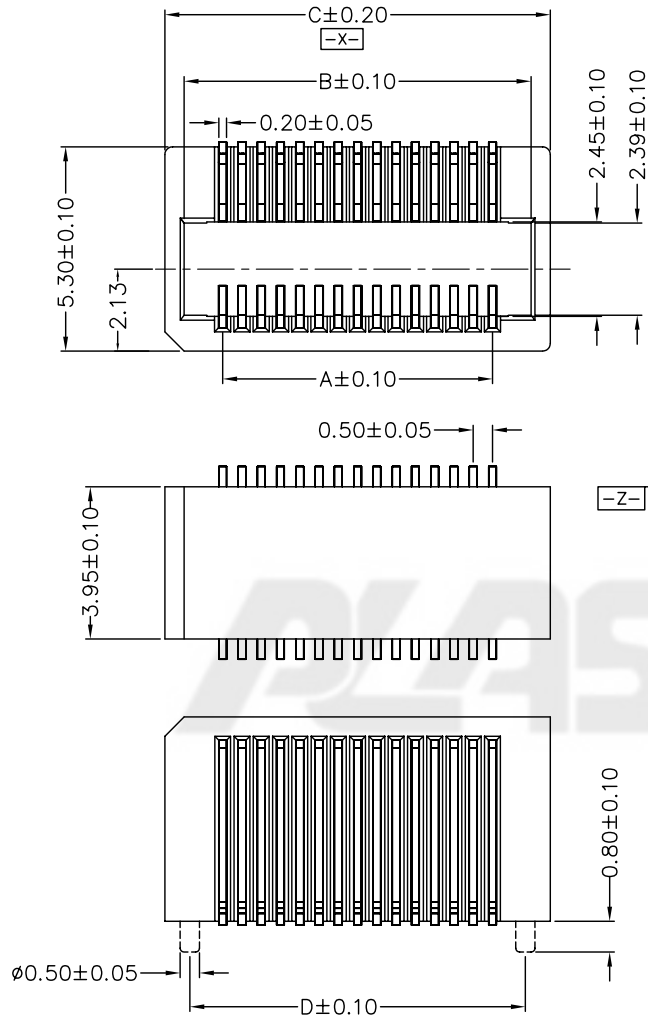
ORIGINAL DRAWN	RAY-LI
CHECK	
APPROVE	Mike.zhang

DATE	08/25 '06
DATE	
DATE	05/20'09

DWG. NO.	600-0000-0095
PARTS NO.(INTENDED USE)	ZVB-XXR1-X-X-* Series

TITLE	CUSTOMER DRAWING 0.5PITCH, B TO B FEMALE SERIES
REV.	15
SHEET	1/1

Rev.	ECN Number	Description	Drawn	APPD.
14	EH06080353		RAY-LI	Wolfe.liu 08/30 '06
15	EH09050057	增加平面度管控	Michael	Mike.zhang



- NOTES: (UNLESS OTHERWISE SPECIFIED)
- DIMENSION SHALL BE INTERPRETED PER ANSI Y14.5M-1994
 - INSERTION FORCE: 110g MAX. PER CONTACT.
 - WITHDRAW FORCE: 11g MIN. PER CONTACT.
 - DURABILITY: 30 CYCLES MIN..
 - CONTACT RETENTION FORCE: 150g MIN. PER CONTACT.
 - CURRENT RATING: 0.5 AMPERE.
 - CONTACT RESISTANCE: 60 m ohms MAX. FOR INITIAL.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC rms./MINUTE.
 - INSULATION RESISTANCE: 100 Megohms MIN..
 - DIM. MARKED ①②③.....SHOULD BE CONTROLLED BY QC
 - MARKED ▽ SHOULD BE CONTROLLED BY THE CPK
 - HARMFUL MATERIAL SHOULD BE COMPLIANT TO DOC. "EI-0005" STANDARDS.
 - PRODUCT NUMBER MATRIX:

ZVB-XXR1-X-X-*
 Number of Contacts
 Angle
 NULL: TUBE
 K: REEL
 0: W/O Locating peg
 1: With Locating peg
 Contact Plating

Definition	Code
⊙ Tin plated:	A
⊙ Gold plated:	
flash B	15μ" F
10μ" E	30μ" J
⊙ Duplex plating:	
flash K	15μ" P
10μ" N	30μ" U
⊙ Standard: B	
⊙ Prefix "V" means lead free plating	

